



INFORMATION DISCLOSURE CITATION

(Use several sheets if necessary)

ATTY DOCKET NO.

41941-00351

SERIAL NO.

10/678,483

Zipparo et al.

FILING

October 2, 2003

GROUP

Not Yet Known

U.S. PATENT DOCUMENTS

EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
mo	1.	5,329,498	07/12/94	Greenstein	367	155	
	2.	6,467,138	10/22/02	Aime	29	25.35	
	3.	5,398,689	03/21/95	Connor et al.	128	662.03	
	4.	5,648,942	07/15/97	Kunkel, III	367	176	
	5.	5,795,299	08/18/98	Eaton et al.	600	459	
	6.	6,100,626	08/08/00	Frey et al.	310	334	
	7.	6,266,857	07/31/01	Corbett, III et al.	29	25.35	
	8.	6,514,618	02/04/03	McKeighen	428	413	
	9.	6,541,896	04/01/03	Piel, Jr. et al.	310	334	
mo	10.	6,559,389	05/06/03	Kornrumpf et al.	174	254	

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
mo	11.	JP 63146699	12/10/86	Japan	—	—	✓	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

mo	12.	Buhrdorf, A. et al; Capacitive Micromachined Ultrasonic Transducers and Their Application; 2001 IEEE Ultrasonic Symposium-933
mo	13.	Noble, R.A., et al; A Cost-effective and Manufacturable Route to the Fabrication of High Density 2D Micromachined Ultrasonic Transducer Arrays and (CMOS) Signal Conditioning Electronics on the Same Silicon Substrate; 2001 IEEE Ultrasonic Symposium-941.

EXAMINER

N. Langley

DATE CONSIDERED

5-19-05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.



